XG-2102CA

Product name XG-2102CA 200.00000MHz +/-100ppm PHPA

Product Number / Ordering code X1M0003010052xx

Please refer to the 9.Packing information about xx (last 2 digits)

Output waveform LV-PECL

Pb free / Complies with EU RoHS directive

Reference weight Typ. 133 mg

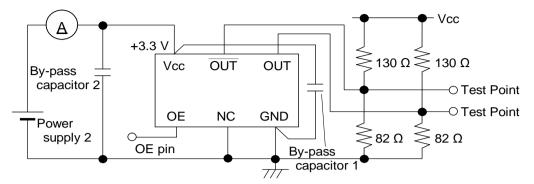
| 1.Absolute maximum ratings | | | | | | |
|----------------------------|---------|------|------|---------|------|---------------------------|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Conditions / Remarks |
| Maximum supply voltage | Vcc-GND | -0.5 | - | 4 | V | - |
| Storage temperature | T_stg | -55 | - | 125 | °C | Storage as single product |
| Input voltage | Vin | -0.5 | - | Vcc+0.5 | V | ST or OE Terminal |

| 2.Specifications(character | istics) | | | | | |
|----------------------------|------------------|-----------|----------|----------|-------------------------|--|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Conditions / Remarks |
| Output frequency | fO | - | 200.0000 | - | MHz | |
| Supply voltage | Vcc | 2.97 | 3.3 | 3.63 | V | - |
| Operating temperature | T_use | 0 | - | 70 | °C | - |
| Frequency tolerance | f_tol | -100 | - | 100 | x10 ⁻⁶ | - |
| Current consumption | lcc | - | - | 60 | mA | OE=Vcc,L_ECL=50ohm |
| Stand-by current | I_std | - | - | - | mA | - |
| Disable current | I_dis | - | - | 2.0 | mA | OE=GND |
| Symmetry | SYM | 45 | - | 55 | % | As output crodding point |
| Output voltage(LV-PECL) | V _{OH} | Vcc-1.025 | 2.35 | Vcc-0.88 | V | - |
| | V _{OL} | Vcc-1.81 | 1.6 | Vcc-1.62 | V | - |
| Output load condition(ECL) | L_ECL | - | 50 | - | Ω | Terminated to Vcc-2.0V |
| Input voltage | V _{IH} | 70% Vcc | - | - | | OE Terminal |
| | V _{IL} | - | - | 30% Vcc | | OE Terminal |
| Rise time | t _r | - | - | 400 | ps | At 20% to 80% output swing |
| Fall time | tf | - | - | 400 | ps | At 20% to 80% output swing |
| Start-up time | t_str | - | - | 10 | ms | - |
| Jitter | t _{DJ} | - | - | N/A | ps | Deterministic Jitter |
| | T _{RJ} | - | - | N/A | ps | Random Jitter |
| | t _{RMS} | - | - | N/A | ps | δ(RMS of total distribution) |
| | t _{p-p} | - | - | N/A | ps | Peak to Peak |
| | t _{acc} | - | - | N/A | ps | Accumulated Jitter(δ) n=2 to 50000 cycles |
| Phase jitter | t _{PJ} | - | - | 0.21 | ps | Off set Frequency: 12kHz to 20MHz |
| Phase noise | L(f) | - | - | - | dBc/Hz | Off set 1Hz |
| | | - | -51.2 | - | dBc/Hz | Off set 10Hz |
| | | - | -81.4 | - | dBc/Hz | Off set 100Hz |
| | | - | -114.3 | - | dBc/Hz | Off set 1kHz |
| | | - | -140.9 | - | dBc/Hz | Off set 10kHz |
| | | - | -149.8 | - | dBc/Hz | Off set 100kHz |
| | | - | -152.3 | - | dBc/Hz | Off set 1MHz |
| Frequency aging | f_age | - | - | - | x10 ⁻⁶ /Year | Included in Frequency tolerance 10 years |

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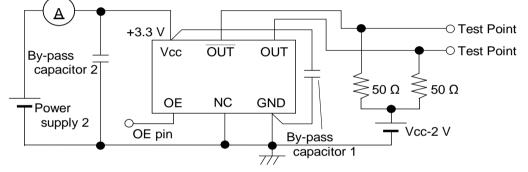
3.Test circuit

1) To observe waveform and current (case 1)



- * The lines from OUT and OUT pin are same length.
- * To measure the disable current, OE pin is connected to GND

2) To observe waveform and current (case 2)



* The lines from OUT and OUT pin are same length.

* To measure the disable current, OE pin is connected to GND

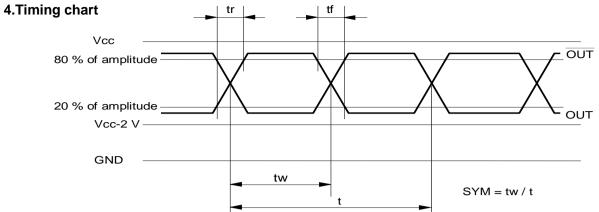
- 3) Measurement condition
- A) Oscilloscope

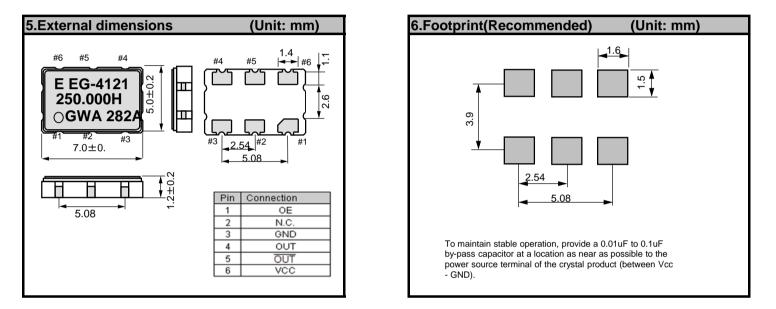
•Bandwidth should be 5 times higher than DUT's output frequency (4 GHz).

•Probe ground should be placed closely from test point and lead length should be as short as possible.

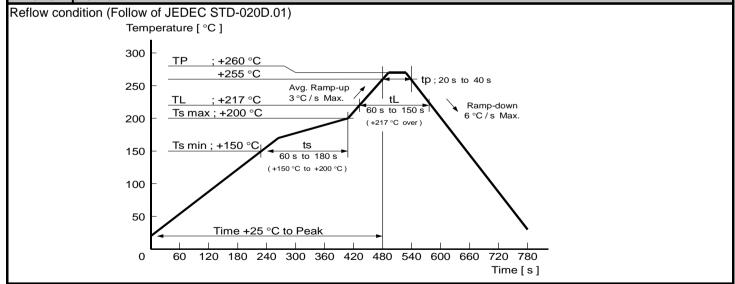
- B) By-pass capacitor 1 (approx. 0.01 µF to 0.1 µF) places closely between Vcc and GND.
- C) By-pass capacitor 2 (approx. 10 µF) places closely between power supply terminals on the board.
- D) Use the current meter whose internal impedance value is small.
- E) Power supply
- Start up time (0 Vg90 %Vcc) of power source should be more than 150 µs and slew rate should be less than 19.8 mV/µs.
- Impedance of power supply should be as low as possible.

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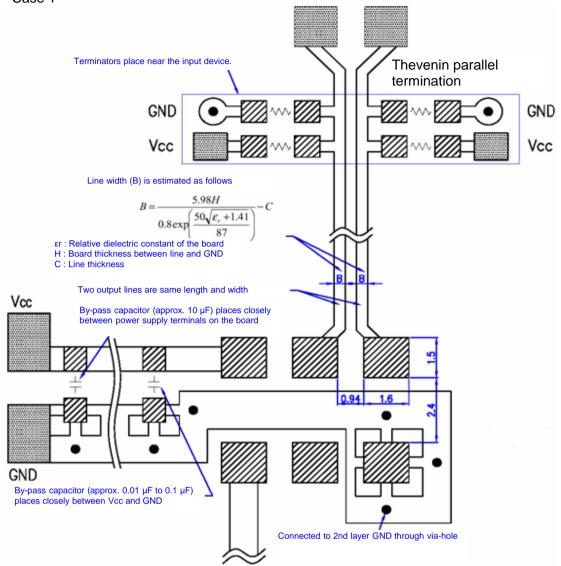




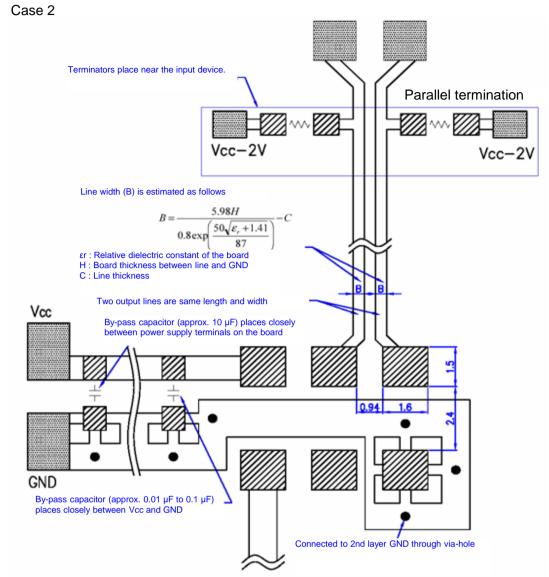
7.Reflow profile



8.PCB layout (2 layers, 2nd layer is all GND pattern) Case 1

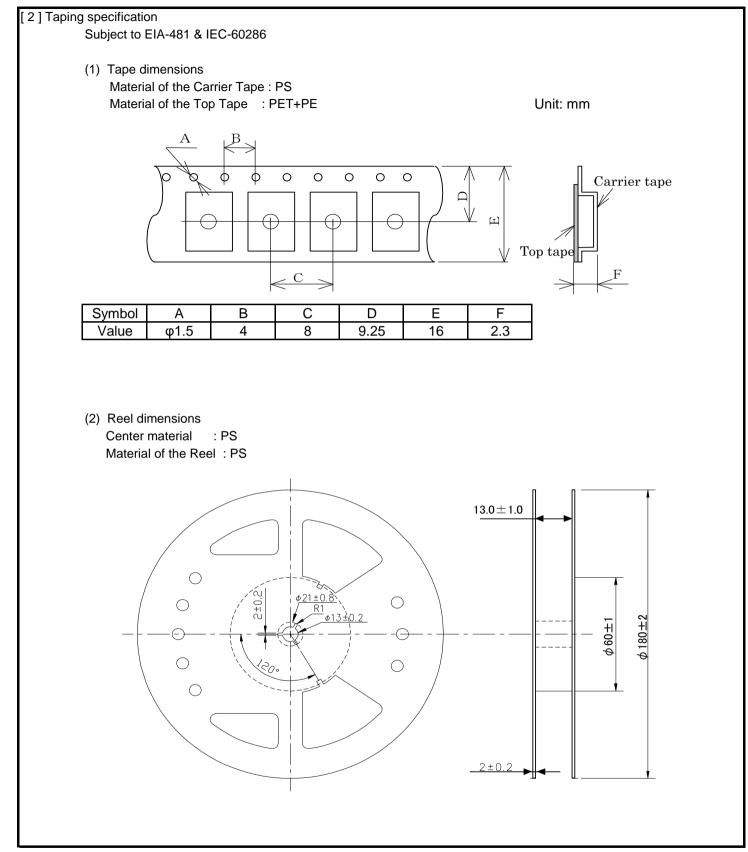


- * By-pass capacitor (approx. 0.01 μ F to 0.1 μ F) places closely between Vcc and GND.
- * By-pass capacitor (approx. 10 μF) places closely between power supply terminals on the board.
- * Please design the two output lines by characteristic impedance 50 Ω and same length, and try to make the output lines as short as possible.
- * Terminators place near the input device.



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| [1]Produc | Product number last 2 digits code(xx) description | | The recommended code is "00" | | | | |
|-----------|---|------------------------------|------------------------------|----------------|--|--|--|
| | X1M0003 | 3010052xx | | | | | |
| | Code | Condition | Code | Condition | | | |
| | 01 | Any Q'ty vinyl bag(Tape cut) | 13 | 500pcs / Reel | | | |
| | 11 | Any Q'ty / Reel | 00 | 1000pcs / Reel | | | |
| | 12 | 250pcs / Reel | | | | | |



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